IN THE CLAIMS:

Please amend the claims as shown below. The status of the claims after amendment will be as follows:

Claims 1 - 16 (cancelled)

17. (currently amended) A lead-free solder ~~as claimed in claim 1 wherein the solder consists~~ consisting of 1.5 - 8 mass % of Cu, 0.01 - 2 mass % of Co, 0.01 - 1 mass % of Ni, and a remainder of Sn and having a liquidus temperature of 420°C or below.

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